

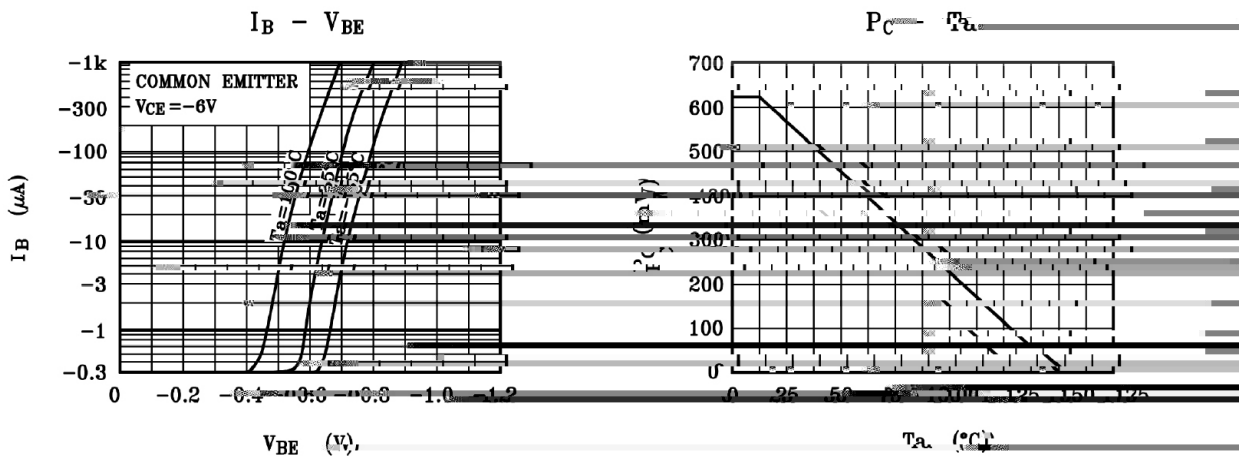
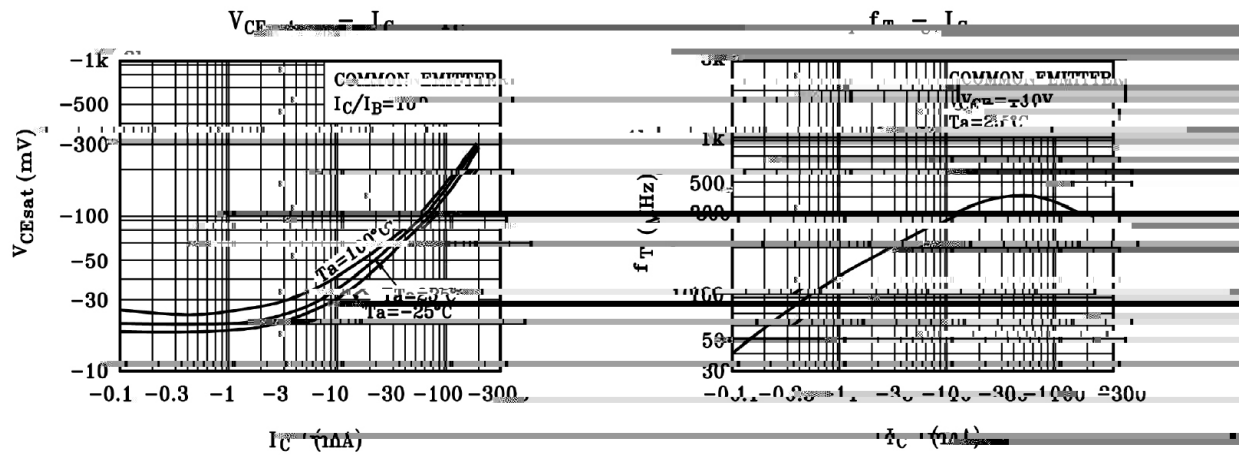
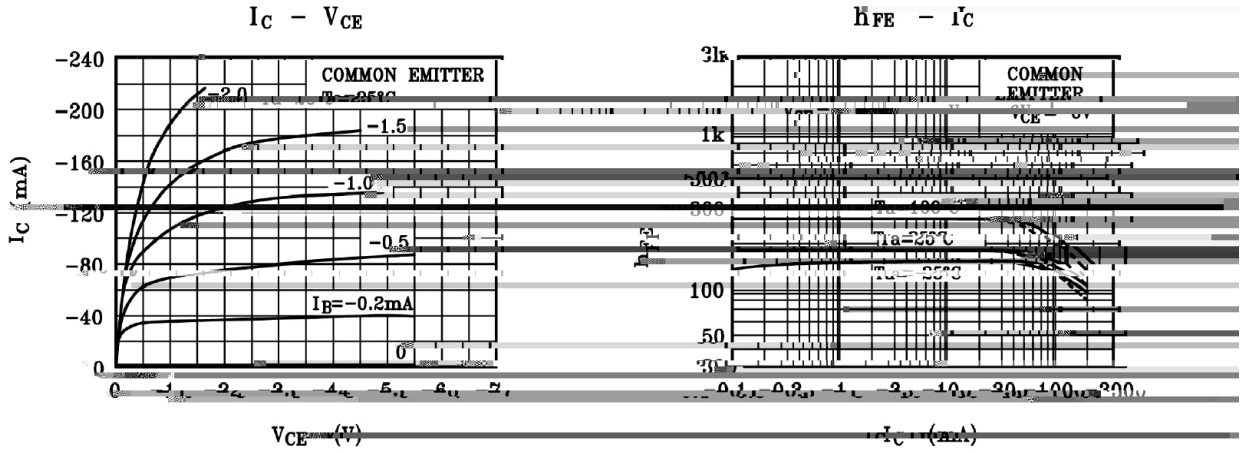
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-50	V
Collector to Emitter Voltage	V_{CEO}	-50	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	I_C	-150	mA
Base Current - Continuous	I_B	-50	mA
Collector Power Dissipation	P_C	625	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-50V$ $I_E=0$			-0.1	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=-5.0V$ $I_C=0$			-0.1	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=-6.0V$ $I_C=-2.0mA$	70		400	
	$h_{FE(2)}$	$V_{CE}=-6.0V$ $I_C=-150mA$	25			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-100mA$ $I_B=-10mA$		-0.1	-0.3	V
Base to Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=-100mA$ $I_B=-10mA$			-1.1	V
Transition Frequency	f_T	$V_{CE}=-10V$ $I_E=1.0mA$	80			MHz
Collector Output Capacitance	C_{ob}	$V_{CB}=-10V$ $I_E=0$ $f=1.0MHz$		4.0	7.0	pF
Base Intrinsic Resistance	$r_{bb'}$	$V_{CB}=-10V$ $I_E=1.0mA$ $f=30MHz$		30		
Noise Figure	NF	$V_{CE}=-6.0V$ $I_C=-0.1mA$ $f=1KHz$ $R_g=10K$		1.0	10	dB

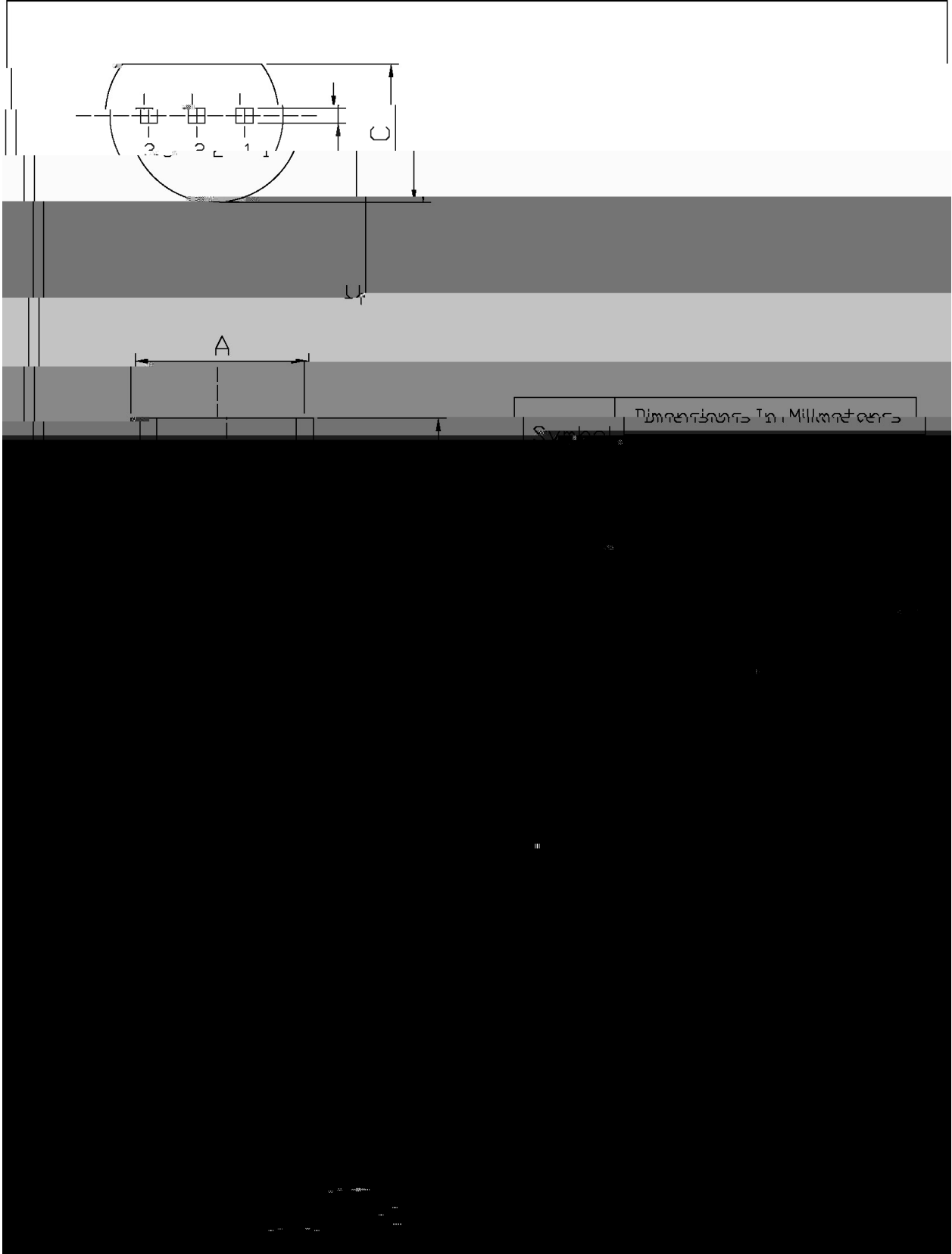
/ Electrical Characteristic Curve



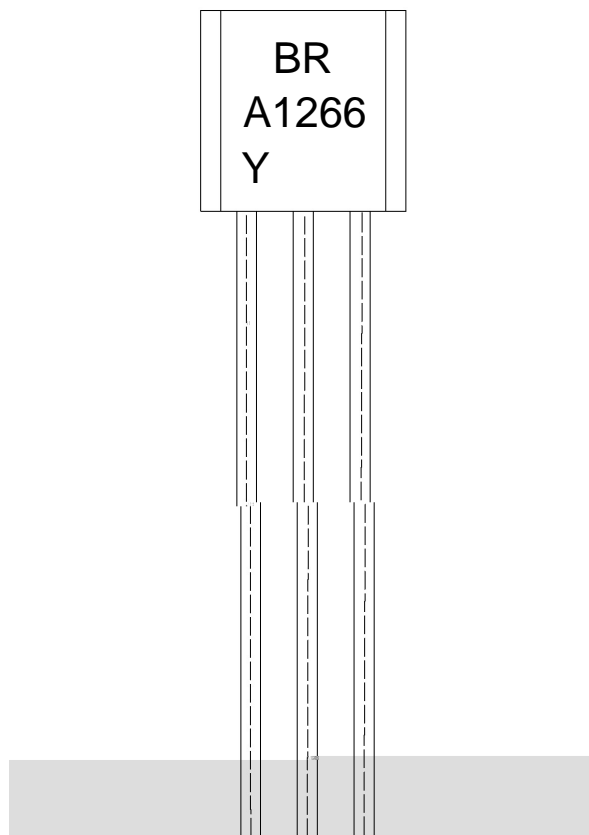
/ Package Dimensions

T0-92

Unit: mm



/ Marking Instructions



BR:

A1266

Y: h_{FE}

Note:

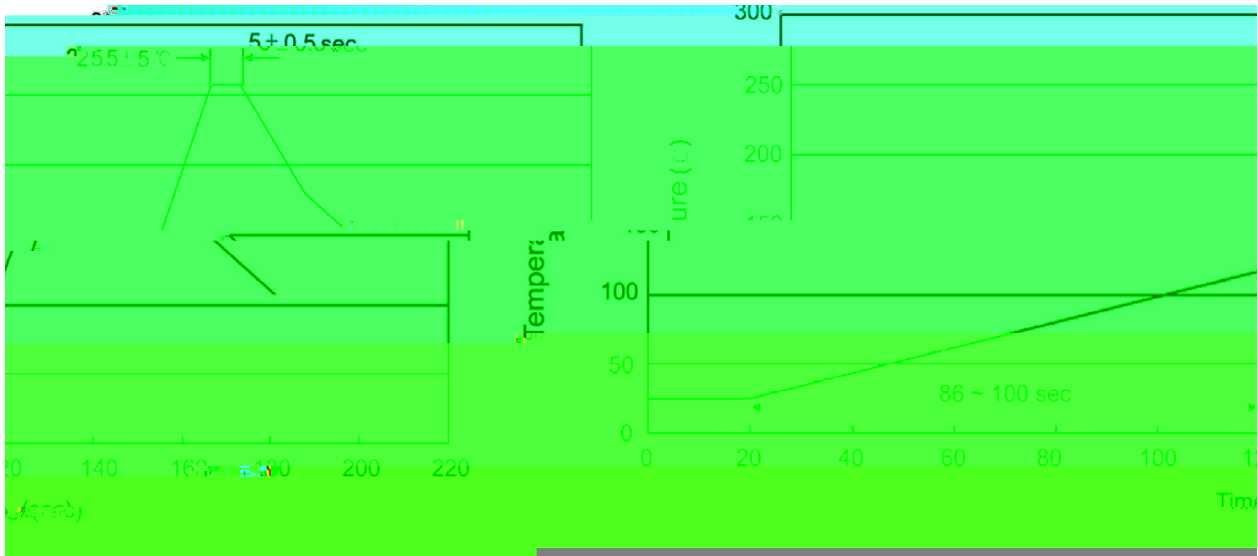
BR: Company Code.

A1266: Product Type.

Y: h_{FE} Classifications Symbol

****: Lot No. Code,code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | |
|---|----------|-------------|--|
| 1 | 25 ~ 150 | 60 ~ 90sec; | 1. Preheating: 25~150 , Time: 60~90sec. |
| 2 | 255±5 | 5±0.5sec; | 2. Peak Temp.: 255±5 , Duration: 5±0.5sec. |
| 3 | 2 ~ 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270±5 10±1 sec. Temp: 270±5 Time: 10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units	Dimension (unit mm ³)

s/479[(Ou.3(45